



# SPECIFICATION FOR APPROVAL

CUSTOMER	ROPLA
CUST. PART NO.	FL201212-XXXX-LRH
CUST. DOC. REV.	
DESCRIPTION	CHIP INDUCTORS(RoHS+HF)
SAMPLE LOT NO.	S201907-0085
PART NO.	FL201212-XXXX-LRH
DOC. REV.	ORIG
DATE	2019/7/17

Once you approve this part, please sign and return this page to the following marked location.

Customer Signature: \_\_\_\_\_ Date: \_\_\_\_\_

This part currently development section.

Production line can produce this series of products.

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TESTED BY	CHECKED BY	APPROVED BY
Jenny Tseng	Adam Lee	K.C Tseng



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# SPECIFICATION FOR APPROVAL

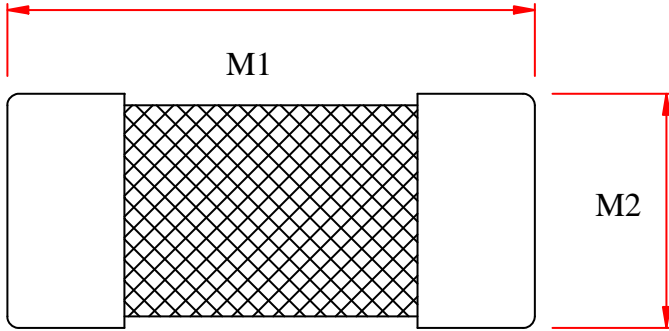
<b>CUSTOMER</b> ROPLA	<b>CUSTOMER P/N</b> FL201212-XXXX-LRH	<b>REV.</b> -	<b>SPL. LOT NO.</b> S201907-0085	
<b>PART NAME</b> CHIP INDUCTORS (RoHS+H.F.)	<b>PART NO.</b> FL201212-XXXX-LRH	<b>REV.</b> ORIG	<b>DATE OF ISSUE</b> 2019/7/17	<b>Q'TY</b> 0 PCS

## ENGINEERING CHANGE NOTICE – RECORD

REVISION NO.	REVISION DESCRIPTION	AUTHOR	DATE	REMARK
ORIG		<i>Adam Lee</i>	2019/7/17	

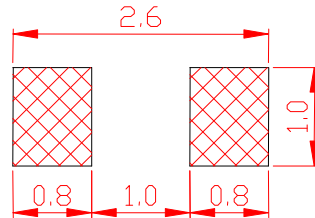
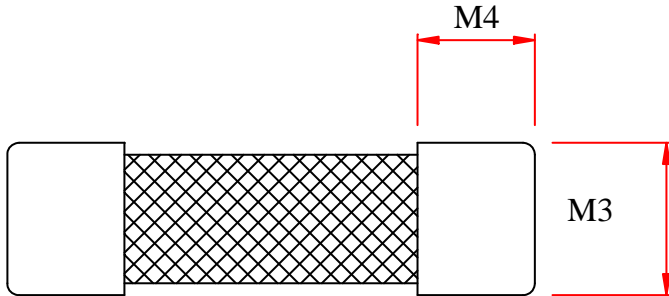
※This is a RoHS and REACH compliant product whose related documents are available on request.  
 ※Graphic is only for dimensionally application.

**1. MECHANICAL DIMENSION**



UNIT: mm

	DIM.	TOL.
<b>M1</b>	2.0	±0.2
<b>M2</b>	1.2	±0.2
<b>M3</b>	1.2	±0.2
<b>M4</b>	0.5	±0.3



**2. ELECTRICAL**

OLD P/N (NEW P/N)	Ind. ( $\mu$ H)	Q Min	Test Freq. (MHz)	SRF MHz Min	DCR Ohm Max	Rated Current (mA)MAX.
FL201212-2R7K-LRH	2.7	45	10	45	0.75	30
FL201212-3R3K-LRH	3.3	45	10	41	0.80	30
FL201212-3R9K-LRH	3.9	45	10	38	0.90	30
FL201212-4R7K-LRH	4.7	45	10	35	1.00	30
FL201212-5R6K-LRH	5.6	50	4	32	0.90	15
FL201212-6R8K-LRH	6.8	50	4	29	1.00	15
FL201212-8R2K-LRH	8.2	50	4	26	1.10	15
FL201212-100K-LRH	10	50	2	24	1.15	15
FL201212-220K-LRH	22	35	1	16	1.10	5

TOLERANCE : K=±10%

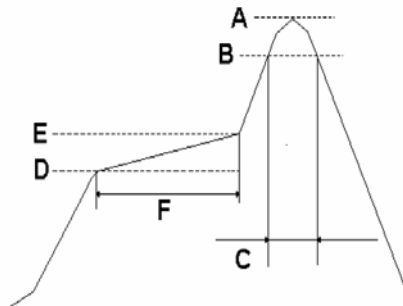
TEST INSTRUMENT: HP4291B & CHROMA-16502

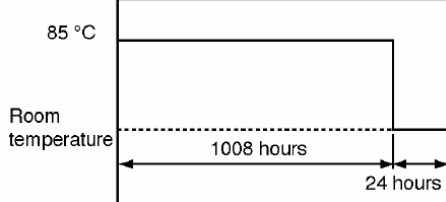
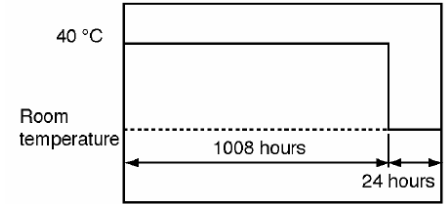
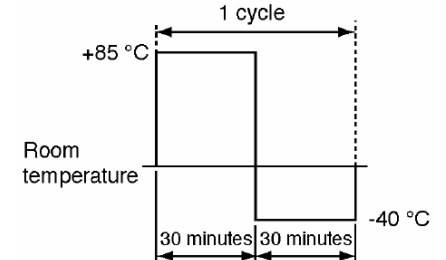
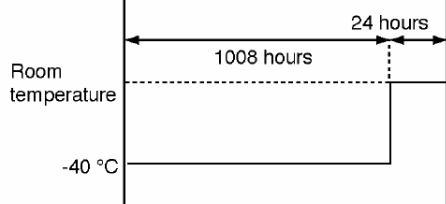
**3. RELIABILITY PERFORMANCE**

Test Item	Performance	Test Condition
Operating temperature range	-55°C to + 125°C	
Storage temperature and umidity ranges	40°C MAX., 70% RH MAX.	
Soldering heat resistance	The chip shall not be cracks. More than 75% of terminal electrode shall be covered with solder.	<p>Preheat: 150°C, 60 seconds                      Solder temperature : 270 ± 5°C                      Flux: Rosin Dip time: 10 ± 1 seconds</p>
Solderability	More than 90% of the terminal electrode shall be covered with new solder.	<p>Preheat: 150°C, 60 seconds Solder temperature: 245 ± 5°C                      Flux: Rosin Dip time: 4 ± 1 seconds</p>

**Recommended Soldering Conditions (REFLOW TEMPERATURE PROFILE) Lead-Free**

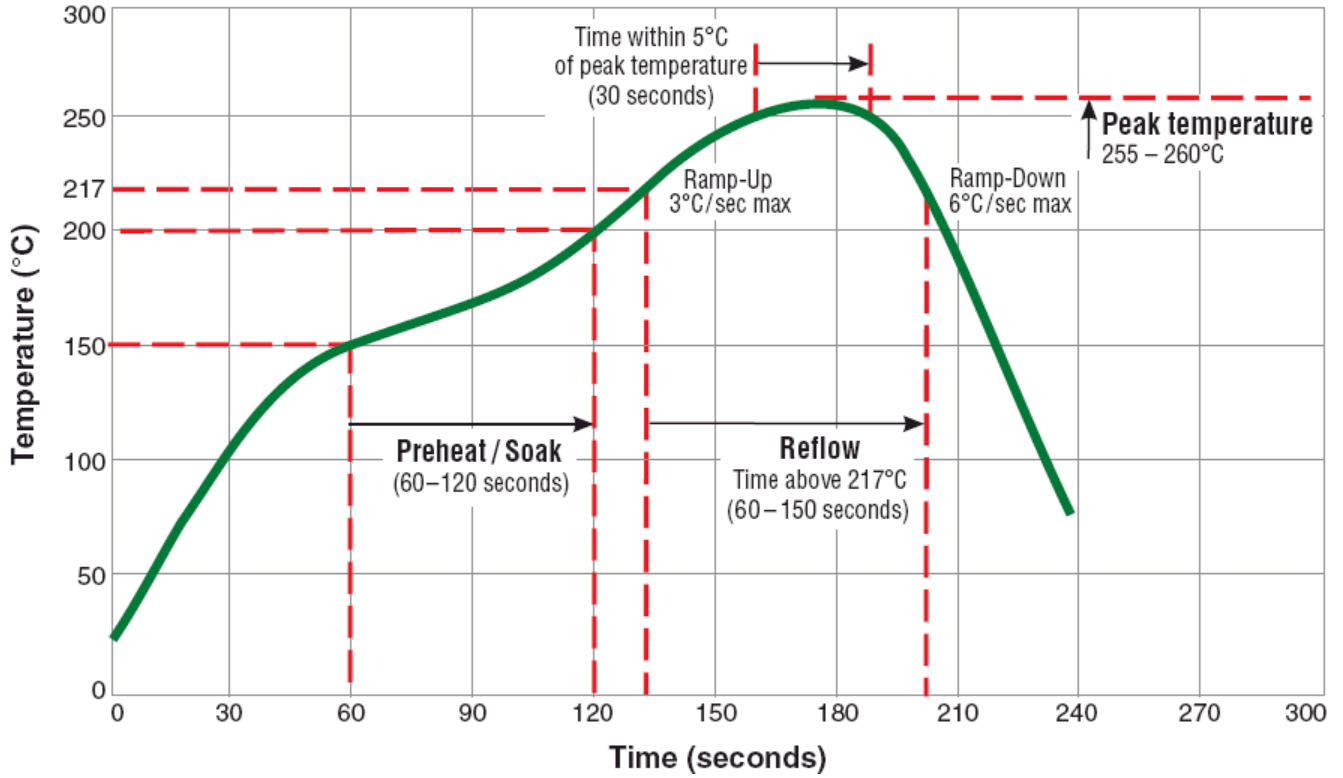
A	260 ± 5°C
B	230 ± 5°C
C	30 ±10 sec
D	150°C
E	180°C
F	90 ± 30sec



Test Item	Performance	Test Condition
<p><b>High temperature resistance</b></p>	<p><b>Appearance: Ferrite shall not be damaged. Impedance: Within±20% of the initial value.</b></p>	<p><b>Temperature: 85±2°C Testing time: 1008±12 hours Measurement: After placing for 24 hours min.</b></p> 
<p><b>Humidity resistance</b></p>	<p><b>Appearance: Ferrite shall not be damaged. Impedance: Within±20% of the initial value</b></p>	<p><b>Humidity: 90 to 95% RH Temperature: 40±2°C Testing time: 1008±12 hours Measurement: After placing for 24 hours min.</b></p> 
<p><b>Thermal Shock</b></p>	<p><b>Appearance: Cracking, chipping or any other defects harmful to the characteristics shall not be allowed. Impedance: Within±20% of the initial value</b></p>	<p><b>Temperature: -40°C, +85°C, kept stabilized for 30 minutes each Cycle: 100 cycles Measurement: After placing for 24 hours min.</b></p> 
<p><b>Low temperature storage life test</b></p>	<p><b>Appearance: Cracking, chipping or any other defects harmful to the characteristics shall not be allowed. Impedance: Within±20% of the initial value.</b></p>	<p><b>Temperature: -40±2°C Testing time: 1008±12 hours Measurement: After placing for 24 hours min.</b></p> 

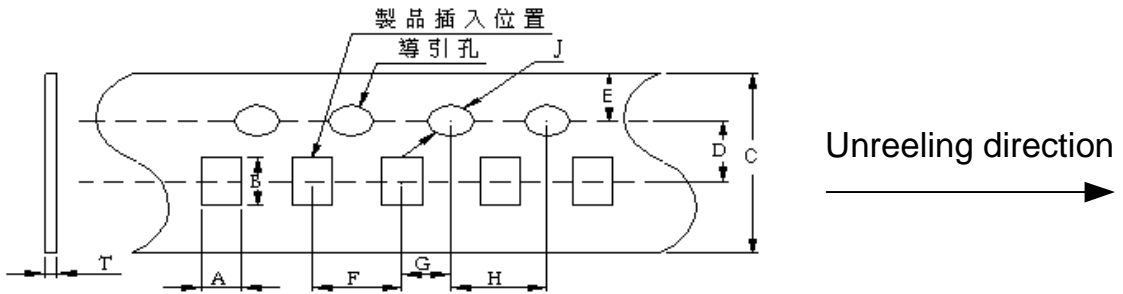
4. TYPICAL RoHS REFLOW PROFILE

Typical RoHS Reflow Profile



**5. PAPER CARRIER TAPE PACKAGING**

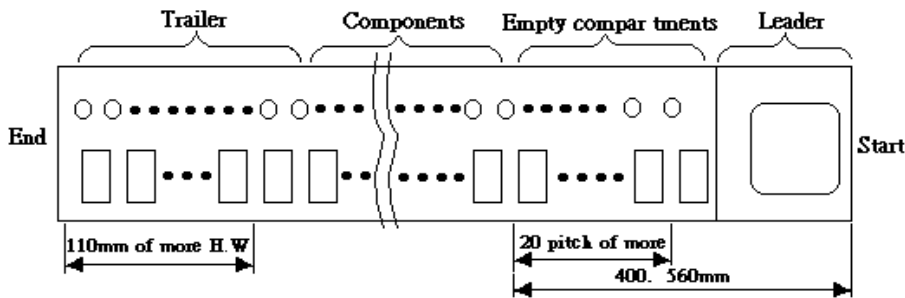
**5.1 DIMENSIONS**



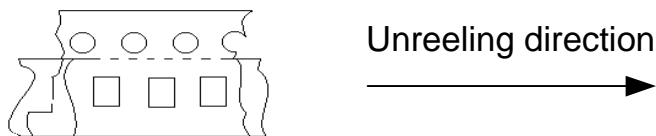
UNIT : mm

	A	B	C	D	E	F	G	H	J	T
DIM.	1.45	2.25	8.00	3.50	1.75	4.00	2.00	4.00	1.55	0.95
TOL	±0.05	±0.05	±0.10	±0.05	±0.10	±0.10	±0.05	±0.10	±0.05	±0.05

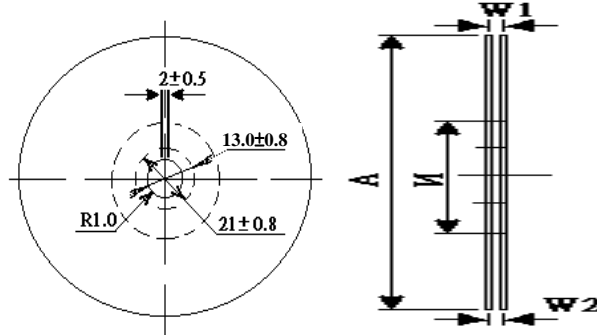
**5.2 LEADER AND TRAILER TAPE**



**5.3 DIRECTION THE DIRECTION SHALL BE SEEN FROM THE TOP OF COVER TAPE**



**5.4 REELS**



UNIT : mm

	DIM.	TOL.
A	178	±2.0
N	50	MIN.
W1	10	±1.5
W2	20	WAX.

**PACKING Q'TY : 4,000 PCS REEL**